TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (DTMOS II)

TK12A60U

Switching Regulator Applications

Unit: mm

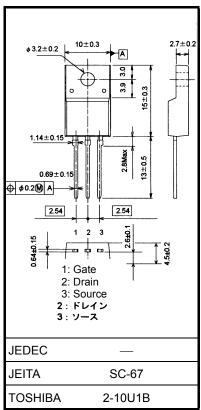
• Low drain-source ON-resistance : $R_{DS (ON)} = 0.36 \Omega (typ.)$ • High forward transfer admittance : $|Y_{fs}| = 7.0 S (typ.)$

• Low leakage current: $I_{DSS} = 100 \mu A (V_{DS} = 600 V)$

• Enhancement-mode: V_{th} = 3.0 to 5.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	600	V	
Drain-gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	600	V	
Gate-source voltage		V_{GSS}	±30	V	
Drain current	DC (Note 1)	ΙD	12		
	Pulse (t = 1 ms) (Note 1)	I _{DP}	24	Α	
Drain power dissipati	on (Tc = 25°C)	P _D	35	W	
Single pulse avalanche energy (Note 2)		E _{AS}	69	mJ	
Avalanche current (Note 3)		I _{AR}	12	Α	
Repetitive avalanche energy		E _{AR}	3.5	mJ	
Channel temperature	!	T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	°C	



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

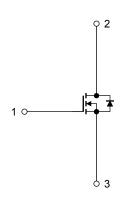
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 0.84 mH, R_G = 25 Ω , I_{AR} = 12 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.





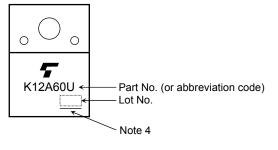
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage current		I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μА
Drain cut-off current		I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	100	μА
Drain-source brea	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600	_	_	V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	3.0	_	5.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 6 A		0.36	0.4	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 6 A	2.0	7.0	_	S
Input capacitance		C _{iss}		_	720	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	55	_	pF
Output capacitance		C _{oss}		_	1700	_	
Switching time	Rise time	t _r	$\begin{array}{c c} 10 \text{ V} & \text{I}_D = 6 \text{ A} & \text{V}_{\text{OUT}} \\ \text{VGS} & \text{V} & \text{S} & \text{RL} = \\ 50 \Omega & \text{V}_{\text{DD}} \approx 300 \text{ V} \\ \end{array}$ Duty \leq 1%, $t_{\text{W}} =$ 10 μs	_	30	_	ns
	Turn-on time	t _{on}		_	60	_	
	Fall time	t _f			8		
	Turn-off time	t _{off}			75		
Total gate charge		Qg		_	14	_	
Gate-source charge		Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$	_	8.5	_	nC
Gate-drain charge		Q _{gd}		_	5.5		

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	12	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	_	24	Α
Forward voltage (diode)	V_{DSF}	I _{DR} = 12 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	$I_{DR} = 12 \text{ A}, V_{GS} = 0 \text{ V},$	_	380	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	5.3	_	μС

Marking

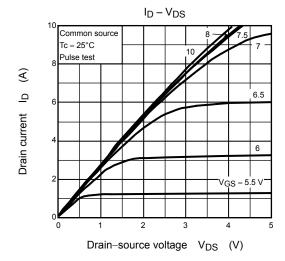


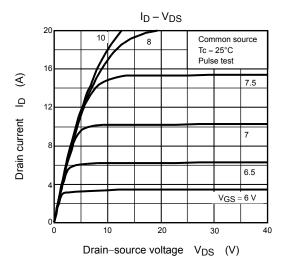
Note 4: A line under a Lot No. identifies the indication of product Labels.

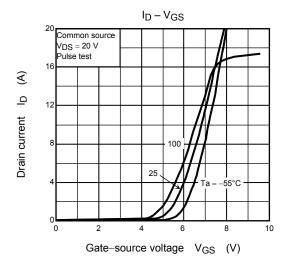
Not underlined: [[Pb]]/INCLUDES > MCV

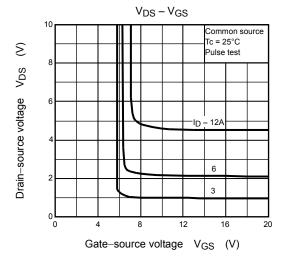
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

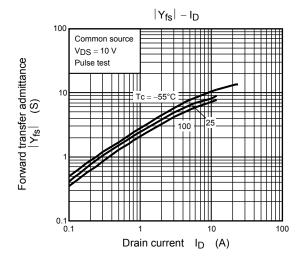
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

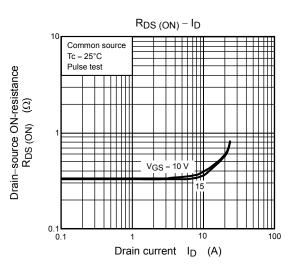


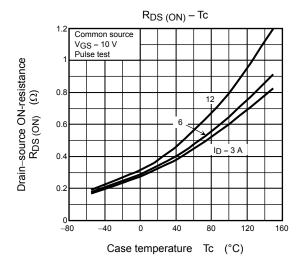


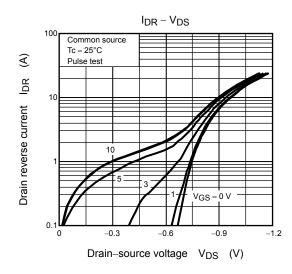


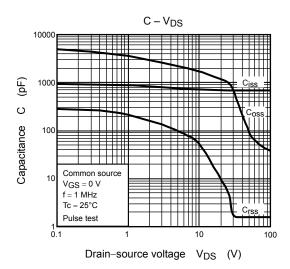


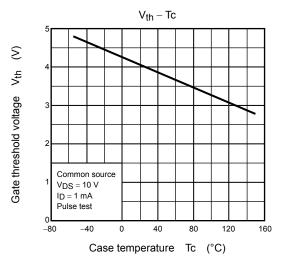


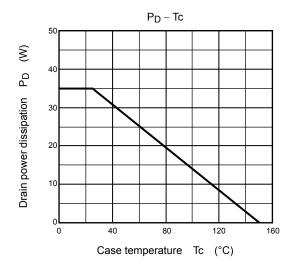


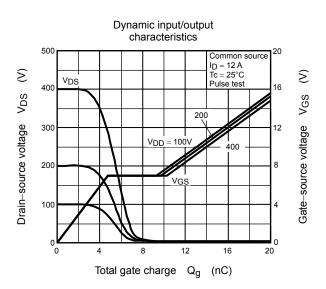


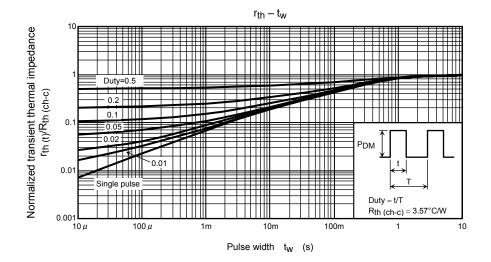


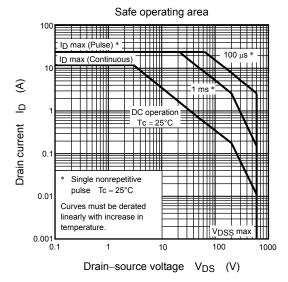


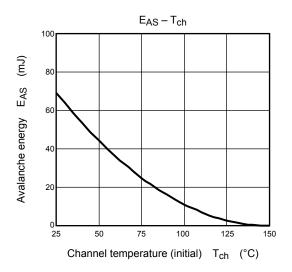


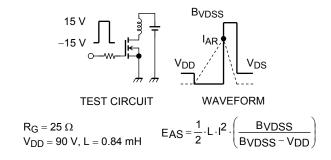












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